### 501990255 07/16/2012

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

# **CONVEYING PARTY DATA**

Name	Execution Date	
Kibum KWON	07/13/2012	
Sungjin SUH	07/13/2012	
Kyoungmin PARK	07/13/2012	

#### RECEIVING PARTY DATA

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# PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13522265

#### CORRESPONDENCE DATA

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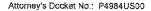
Address Line 4: Vienna, VIRGINIA 22182

ATTORNEY DOCKET NUMBER:	P4984US00
NAME OF SUBMITTER:	Hae-Chan Park

Total Attachments: 2

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PATENT REEL: 028558 FRAME: 0845 OP \$40.00 1352226





### **ASSIGNMENT**

Whereas, Assignor has invented certain new and useful processes, machines, articles of manufacture, compositions of matter, and/or improvements thereof ("Invention") disclosed in

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issued	☐ up ("Patent");		ited States Le	etters Pat	ent, Patent I	Number _	мичения создавания создавания создавания на при	, has
to:	Whereas,	Assignor de	esires to conv	ey all rig	hts, titles, a	nd intere	sts in and to	the same
			PANTECH Co Pantech Bldg. Sangam-dong 121-270 Seou Republic of Ko	., I-2, DM g, Mapo-g ul				

PANTECH CO., LTD. herein further referred to as ("Assignee").

Now, for valuable consideration by Assignee to Assignor, the receipt of which is hereby acknowledged, and for other good and valuable consideration, Assignee and Assignor hereby agree as follows:

Assignor hereby conveys, assigns, sells and transfers to Assignee all rights, title and interests in and to the Invention disclosed in said application and in and to any Letters Patent of the United States (US), any continuation, division, renewal, or substitute thereof, and hereby grant to Assignee the right to apply in its own name for patents or Inventor's certificates and related rights heretofore or hereafter filed for the Invention in any and all countries, including (without limitation) all rights to claim priority based thereon, all patents granted thereon and all reissues, extensions and renewals thereof.

Assignor hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

Assignor further covenants that Assignee will, upon Assignee's request, be provided promptly with all pertinent facts and documents relating to the Invention, Patent, Application and any patents granted thereon, as may be known and accessible to Assignor, and Assignor will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to Assignee or Assignee's legal representative any and all papers, instruments or affidavits required to apply for, protect, obtain, maintain, issue, defend and enforce the Application, Patent, Invention, whether in the US or any and all foreign countries



and any patents granted thereon and/or for obtaining any reissue or reissues of any patent which may be granted for the invention and perform such further acts which may be necessary or desirable to carry out the intent of this agreement as the Assignee thereof shall hereafter require and prepare at assignee's expense.

IN WITNESS WHEREOF, Assignor has hereunto set hand and seal.

First Inventor's Name:	Kibum KWON
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First Inventor's Signature:	hi Bem Rowon
Date:	July 13, 2012
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Second Inventor's Signature:	M/L
Date:	July 13, 2012
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Third Inventors' Signature:	- Winner
Date:	July 13,2012